Surface Mount
Oven Stabilized Oscillator
DOXSC Series
OCXO or VCOCXO

CONNOR WINFIELD
HCW

Description:

Connor-Winfield's high stability DOXSC Series is an exceptionally precise frequency standard, excellent for use in cellular base stations, test equipment, Synchronous Ethernet and VSAT applications.
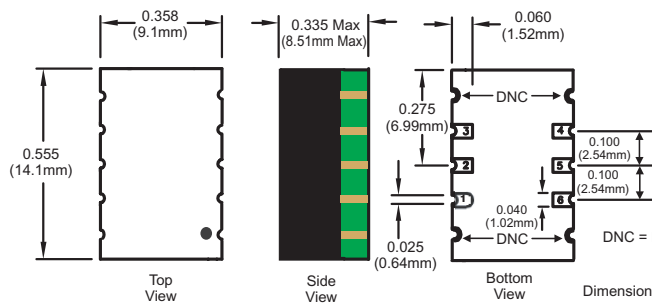
Based on an SC-cut crystal, the DOXSC Series offers low aging and tight stability in a 9x14mm surface mount package.
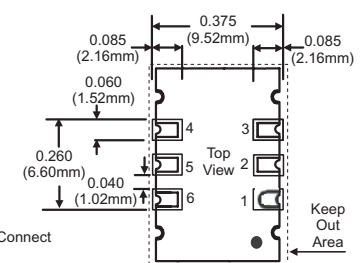
Features:

- OCXO or VCOCXO
- 3.3 Vdc Operation
- SMT Package
- Frequency Stability: ±20ppb or ±50ppb
- Temperature Ranges:
  0 to 70°C, -20 to 75°C or -40 to 85°C
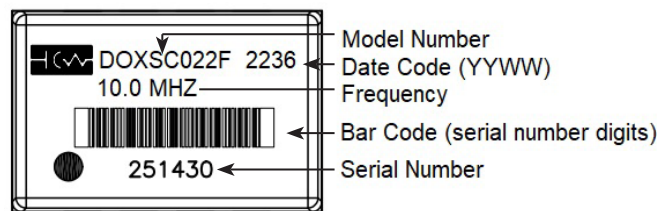- Low Phase Noise
- LVCMOS Output
- RoHS Compliant / Lead Free ✓RoHS

Package Outline

0.358 (9.1mm)
0.335 Max (8.51mm Max)
0.060 (1.52mm)
0.275 (6.99mm)
DNC
0.100 (2.54mm)
0.100 (2.54mm)
0.555 (14.1mm)
0.040 (1.02mm)
DNC
0.025 (0.64mm)

Top View Side View Bottom View

DNC = Do Not Connect

Suggested Pad Layout

0.375 (9.52mm)
0.085 (2.16mm)
0.085 (2.16mm)
0.060 (1.52mm)
0.260 (6.60mm)
0.040 (1.02mm)
Top View
Keep Out Area

Dimensional Tolerance: +/-0.005 (0.127mm)

Marking Diagram

HCW DOXSC022F 2236 — Model Number
2236 — Date Code (YYWW)
10.0 MHZ — Frequency
Bar Code (serial number digits)
251430 — Serial Number

Pad Connections

1:	N/C or Voltage Control
2:	Do Not Connect*
3:	Ground
4:	Output
5:	Do Not Connect*
6:	Supply Voltage (Vcc)

*DO NOT connect "DNC" pads to ground or supply rails.

Ordering Information

DOXSC	02	0	F	-020.0M
Oscillator Type	Frequency Stability	Temperature Range	Voltage Control Option	Output Frequency
3.3 Vdc LVCMOS Output Surface Mount OCXO	02 = ±20 ppb 05 = ±50 ppb 10 = ±100ppb	0 = 0 to 70°C 1 = -20 to 75°C 2 = -40 to 85°C	F = OCXO (Fixed Freq.) V = VCOCXO (Voltage Controlled)	Frequency Format -xxx.xM Min * -xxx.xxxxxxM Max *

* Number of allowable digits after the decimal point. M = MHz

Order Part Number Example: DOXSC020F-020.0M

Attention: System Designers please review Application Note AN2093:
System Design Information and Printed Circuit Board Layout Guidelines for OCXO Oscillators.
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RoHS COMPLIANT

Absolute Maximum Ratings

Parameter	Minimum	Nominal	Maximum	Units	Notes
Storage Temperature	-55	-	125	°C	
Supply Voltage - 3.3 Vdc (Vcc)	-0.5	-	4.5	Vdc	
Control Voltage (Vc)	-0.5	-	Vcc+0.5	Vdc	

Operating Specifications

Parameter	Minimum	Nominal	Maximum	Units	Notes
Center Frequency (Fo)	10	-	50	MHz	
Frequency Stability vs. Change in Temperature					
Option 02	-20	-	20	ppb	1
Option 05	-50	-	50	ppb	1
Option 10	-100	-	100	ppb	1
Operating Temperature Range					
Option 0	0	-	70	°C	
Option 1	-20	-	75	°C	
Option 2	-40	-	85	°C	
Frequency Calibration	-1.0	-	1.0	ppm	2
Frequency Stability vs Load	-20	-	20	ppb	±5%
Frequency Stability vs Voltage	-20	-	20	ppb	±5%
Aging: Daily	-	±2	±5	ppb/day	3
Aging: First Year	-0.3	-	0.3	ppm	
Total Frequency Tolerance (20 Years)	-3.0	-	3.0	ppm	4
Supply Voltage (Vcc)	3.13	3.30	3.47	Vdc	5
Power Consumption Vcc = Nominal Voltage					
Commercial Temperature Range: 0 to 70 °C					
Turn On	-	-	2.5	W	
Steady State @ 25°C	-	-	1.1	W	
Industrial Temperature Range: -40 to 85 °C					
Turn On	-	-	3.0	W	
Steady State @ 25°C	-	-	1.3	W	
Phase Jitter: (BW: 12 KHz to Fo/2 MHz)	-	0.25	0.35	ps RMS	
Allan Deviation (Tau=1s) Fo=10MHz	-	8.0E-11	-		
Start-Up Time	-	-	10	ms	6
Warm Up Time (Within Specification @ 25°C)	-	-	60	s	
Warm Up Time (Within Specification @ -40°C)	-	-	90	s	

CMOS Output Characteristics

Parameter	Minimum	Nominal	Maximum	Units	Notes
Load	-	15	-	pF	7
Output Voltage					
Output Voltage: High (Voh)	2.7	-	-	V	
Low (Vol)	-	-	0.3	V	
Output Current: High (Ioh)	-4	-	-	mA	
Low (Iol)	-	-	4	mA	
Duty Cycle at 50% of Vcc	45	50	55	%	
Rise / Fall Time: 10% to 90%	-	-	5.0	ns	

Typical Phase Noise Characteristics

Parameter	Fo=10 MHz	Fo=20.0MHz	Fo=40.0MHz	Units	Notes
@ 1 Hz offset	-85	-77	-72	dBC/Hz	
@ 10 Hz offset	-110	-107	-99	dBC/Hz	
@ 100 Hz offset	-136	-129	-126	dBC/Hz	
@ 1 KHz offset	-152	-148	-145	dBC/Hz	
@ 10 KHz offset	-154	-154	-160	dBC/Hz	
@ 100 KHz offset	-155	-155	-160	dBC/Hz	
@ 1MHz offset	-158	-157	-161	dBC/Hz	

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Input Characteristics - Voltage Controlled Option

Parameter	Minimum	Nominal	Maximum	Units	Notes
Control Voltage Range:	0.30	1.65	3.00	V	8
Frequency Pullability:	±3.0	±5.0	±10.0	ppm	9
Input Impedance	100K	-	-	Ohms	
Linearity	-	-	±5	%	

Package Characteristics

DOX Series Package	Package consisting of a FR-4 substrate and Ryton-R-4 cover. Water Resistant package, non-hermetic seal. (Engineering Properties of Ryton R-4 Application Note AN2100)

Environmental Characteristics

Shock	500 G's 1ms, Halfsine, 3 shocks per direction, per MIL-STD 202G, Method 213B Test Condition D.
Sinusoidal Vibration	0.06" D.A. or 10G's Peak, 10 to 500 Hz, per MIL-STD-202G, Method 204D, Test Condition A.
Random Vibration	5.35 G's rms. 20 to 2000 Hz per MIL-STD-202G, Method 214,Test Condition 1A, 15 minutes each axis.
Moisture	10 cycles, 95% RH, Per MIL-STD-202G, Method 112.
Marking Permanency	Per MIL-STD-202G, Method 215J.
Solder Process Recommendations:	RoHS compliant, lead free. See solder profile on page 4.
In-line reflow:	Refer to recommended reflow pre-heat and reflow temperatures on page 4. Package material consist of Ryton R-4 high temperature cover with FR4 substrate. Component solder is Pb free high temperature eutectic alloy with a melting point of 221°C.
In-line oven profile:	We recommend using KIC profiler or similar device placing one of the thermocouples on the device to insure that the internal package temperature does not exceed 221°C.
Removal of device:	If for any reason the device needs to be removed from the board, use a temperature controlled repair station with profile monitoring capabilities. Following a monitored profile will insure the device is properly pre-heated prior to reflow. Refer to IPC 610E for inspection guidelines.
Recommended Cleaning Process: (If required)	
	Device is non-hermetic, water resistance with four weep holes, one in each corner to allow moisture to be removed during the drying cycle. We recommend in-line warm water wash with air knife and drying capabilities. If cleaner does not have drying capability, then use hot air circulated oven. Boards should be placed in the oven vertically for good water runoff.
	Device must be dried properly prior to use!
Note: If saponifier is used make sure the device is rinsed properly to insure all residues are removed. PH of saponifier should not exceed 10.	
Drying Temperature:	Between 85 to 100°C.
Drying Time:	Time will vary depending on the board size.
Caution: Do not submerge the device!	

Notes:

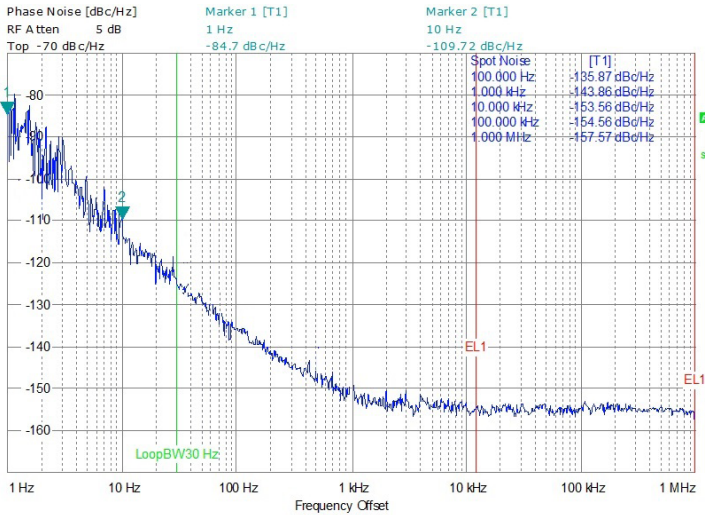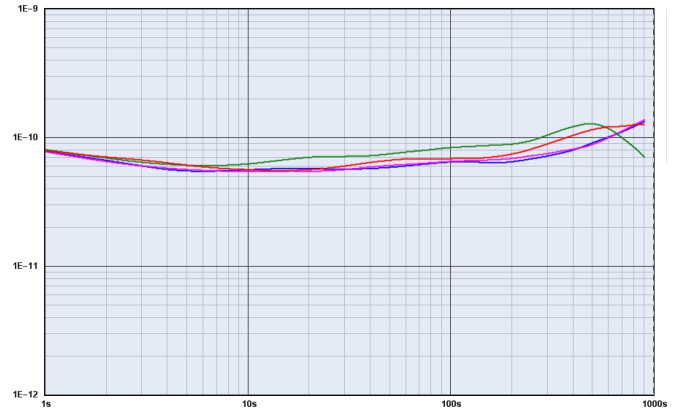*1. Frequency stability vs. change in temperature. [±(Fmax - Fmin)/(2*Fo)].*

2. Initial calibration @ 25°C. For OCXO with voltage control option, the control voltage must be fixed.

3. After 10 days of operation

4. Inclusive of calibration @ 25°C, frequency vs. change in temperature, change in supply voltage (±5%), load change (±5%), shock and vibration and 20 years aging

5. Minimum "Power On Time" after rail rises from 0 to within +/-5% of Vcc = 1 second.
Supply voltage must reach Vcc level monotonically.

6. 10ms start time is guaranteed when supply voltage reaches Vcc level monotonically.

7. Attention: To achieve optimal frequency stability, and in some cases to meet the specification stated on this data sheet, it is required that the circuit connected to this OCXO output must have the equivalent input capacitance that is specified by the nominal load capacitance. Deviations from the nominal load capacitance will have a graduated effect on the stability of approximately 20 ppb per pF load difference.

8. Positive slope. (Frequency increases as Vc voltage increases). To ensure proper operation of VCOCXO's, the control voltage input must be biased the nominal control voltage. Failure to bias the Vc input may cause an unstable output condition.

9. Referenced to Fo.

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CONNOR WINFIELD

Typical Phase Noise (Fo=10MHz)

Phase Noise [dBc/Hz]
RF Atten   5 dB
Top -70 dBc/Hz

Marker 1 [T1]
1 Hz
-84.7 dBc/Hz

Marker 2 [T1]
10 Hz
-109.72 dBc/Hz

Spot Noise	[T1]
100.000 Hz	-135.87 dBc/Hz
1.000 kHz	-143.86 dBc/Hz
10.000 kHz	-153.56 dBc/Hz
100.000 kHz	-154.56 dBc/Hz
1.000 MHz	-157.57 dBc/Hz

LoopBW30 Hz

Frequency Offset

Typical ADEV (Fo=10MHz)

LVCMOS Test Circuit

POWER SUPPLY

Vcc

10uF to 100 uF   0.01uF

6 5 4
1 2 3

Output

15 pF

Pad 1
VCOCXO = Vc
OCXO = NC

DNC = Do Not Connect
DO NOT connect "DNC" pads
to ground or supply rails.

RoHS Solder Profile

Temperature

260°C   260°C
220°C
180°C
150°C
120°C

0

Up to 120 s
Typical

10 s
60 to 90 s
Typical

Meets IPC/JEDEC J-STD-020C
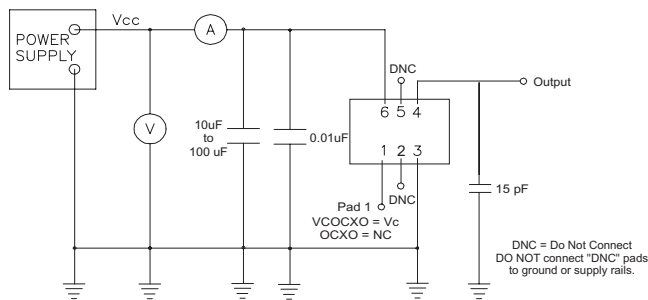
Tape and Reel Information

MEETS EIA−481A & EIAJ−1009B
500 PCS/REEL MAXIMUM

DIRECTION OF FEED (CUSTOMER)

.157 (4.0mm) (Po)
.079 (2.0mm) (P2)
.059 (1.5mm) DIA.
.069 (1.75mm) (E1)
.559 (14.2mm) (F)
1.260 (32.0mm) (W)
1.118 (28.4mm)
SM-MECH51
.630 (16.0mm) (P)
.059 (1.5mm) DIA. (D1)

8.45 DIA (214.6mm) DIA
.08 (2.0mm)
1.00 DIA (25.4mm)

1.31 (33.27mm)
.08 (2.0mm)
.08 (2.0mm)
13.00 (330.2mm)
3.15 (80mm)
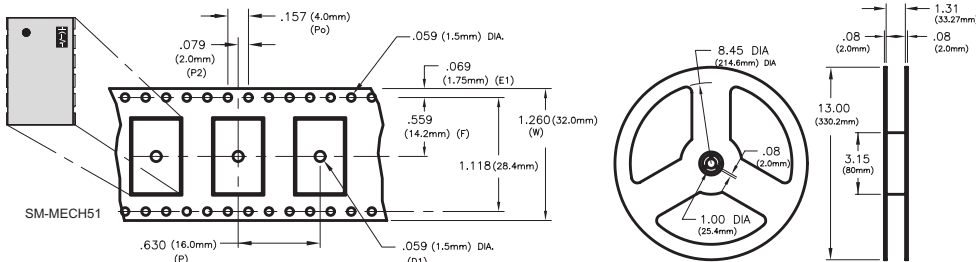
CMOS Output Waveform

1V/Div
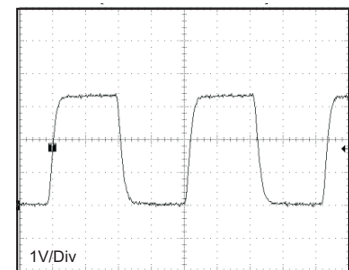
Revision History

Revision	Date	Note
00	04/20/22	New issue
01	07/07/22	Updated Phase Noise Characteristics
02	09/13/22	Updated Marking Configuration

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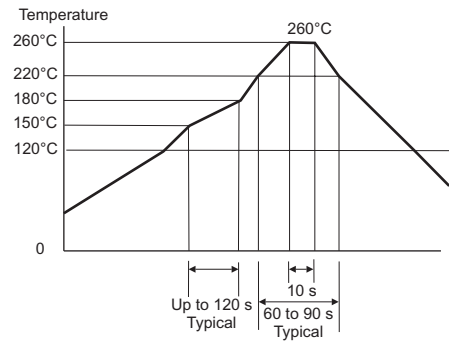| Bulletin	Cx321
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